



2.0A SBR® SURFACE MOUNT SUPER BARRIER RECTIFIER

Features

- Ultra Low Forward Voltage Drop ٠
- Patented Super Barrier Rectifier Technology •
- Soft, Fast Switching Capability
- 150°C Operating Junction Temperature
- Lead Free Finish, RoHS Compliant (Note 1)
- Green Molding Compound (No Halogen and Antimony) (Note 2)

Mechanical Data

- Case: SMA
- Case Material: Molded Plastic, UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish.) Solderable per MIL-STD-202, Method 208 @3
- Polarity Indicator: Cathode Band
- Weight: 0.064 grams (approximate)



Top View



Bottom View

Ordering Information (Note 3)

Part Number	Case	Packaging
SBR2U30SA –13	SMA	5000/Tape & Reel

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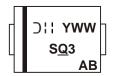
Notes: 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes.

2. Product manufactured with Data Code 0924 (week 24, 2009) and newer are built with Green Molding Compound.

3. For packaging details, go to our website at http://www.diodes.com.

Marking Information

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SQ3 = Product Type Marking Code DII = Manufacturers' code marking YWW = Date Code Marking Y = Last digit of year (ex: 7 for 2007) WW = Week code (01 to 53) AB = Foundry and Assembly Code



Maximum Ratings @T_A = 25°C unless otherwise specified

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Single phase,	nair wave,	60HZ,	resistive	or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _{RM}	30	V
RMS Reverse Voltage	V _{R(RMS)}	21	V
Average Rectified Output Current (See Figure 1)	lo	2.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	30	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance Thermal Resistance Junction to Soldering (Note 4) Thermal Resistance Junction to Ambient (Note 5)	R _{θJS} R _{θJA}	5 128	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	TYP	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	V _{(BR)R}	30	-	-	V	I _R = 400 μA
			0.21	0.26	v	$I_F = 0.1A, T_J = 25^{\circ}C$
			0.11	0.15		I _F = 0.1A, T _J = 125°C
Forward Voltage Drop	V _F		0.31	0.35		$I_F = 1.0A, T_J = 25^{\circ}C$
			0.23	0.30	v	I _F = 1.0A, T _J = 125°C
			0.36	0.40		$I_F = 2.0A, T_J = 25^{\circ}C$
			0.30	0.33		$I_F = 2.0A, T_J = 125^{\circ}C$
Leakage Current (Note 6)			210	500	μΑ	V _R = 30V, T _J = 25 °C
	I _R		23	100	mA	V _R = 30V, T _J = 125 °C

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Notes: 4. Theoretical R_{OJS} calculated from the top center of the die straight down to the PCB cathode tab solder junction.

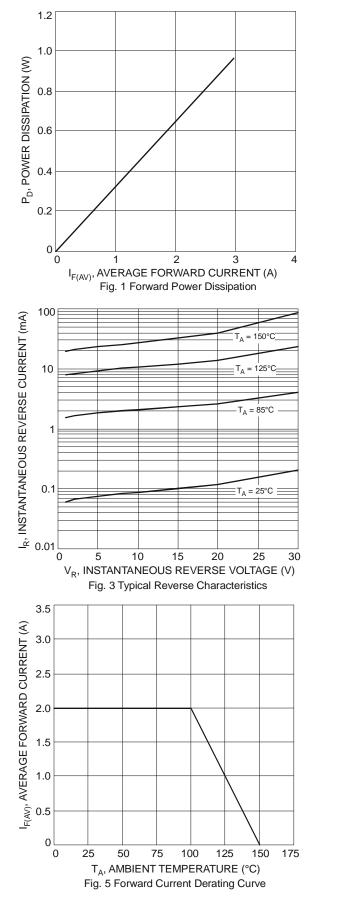
5. FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com. T_A = 25°C

6. Short duration pulse test used to minimize self-heating effect.

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SBR2U30SA



SBR is a registered trademark of Diodes Incorporated. SBR2U30SA Document number: DS30997 Rev. 8 - 2



10,000

1,000

100

10

1

10,000

1,000

100

10

1

150

125

100

75

50

25

0

0

5

 $\mathsf{T}_{\mathsf{A}},$ AMBIENT TEMPERATURE (°C)

C_T, TOTAL CAPACITANCE (pF)

0

= 150°0

0.2

1

10

15

V_R, DC REVERSE VOLTAGE (V)

Fig. 6 Operating Temperature Derating

20

25

V_R, DC REVERSE VOLTAGE (V)

Fig. 4 Total Capacitance vs. Reverse Voltage

= 85°C

25°C

0.4

V_F, INSTANTANEOUS FORWARD VOLTAGE (V) Fig. 2 Typical Forward Characteristics

0.6

10

0.8

100

 $= -55^{\circ}$

 $T_A = 125^{\circ}C$

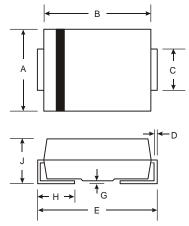
I_F, INSTANTANEOUS FORWARD CURRENT (mA)



30

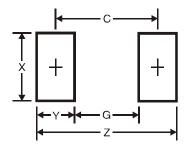


Package Outline Dimensions



SMA			
Dim	Min	Max	
Α	2.29	2.92	
в	4.00	4.60	
С	1.27	1.63	
D	0.15	0.31	
ш	4.80	5.59	
G	0.05	0.20	
Н	0.76	1.52	
J	2.01	2.30	
All Dimensions in mm			

Suggested Pad Layout



Dimensions	Value (in mm)
Z	6.5
G	1.5
Х	1.7
Y	2.5
С	4.0

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